

Data sheet acquired from Cypress Semiconductor Corporation. Data sheet modified to remove devices not offered.

# CY74FCT163245 CY74FCT163H245

16-Bit Transceivers

SCCS051 - February 1997 - Revised March 2000

### Features

- Low power, pin-compatible replacement for LCX and LPT families
- 5V tolerant inputs and outputs
- 24 mA balanced drive outputs
- · Power-off disable outputs permits live insertion
- Edge-rate control circuitry for reduced noise
- FCT-C speed at 4.1 ns
- Latch-up performance exceeds JEDEC standard no. 17
- Typical output skew < 250ps
- Industrial temperature range of -40°C to +85°C
- TSSOP (19.6-mil pitch) or SSOP (25-mil pitch)
- Typical V<sub>olp</sub> (ground bounce) performance exceeds Mil Std 883D
- V<sub>CC</sub> = 2.7V to 3.6V
- ESD (HBM) > 2000V

CY74FCT163H245

- Bus hold on data inputs
- Eliminates the need for external pull-up or pull-down
  resistors
- Devices with bus hold are not recommended for translating rail-to-rail CMOS signals to 3.3V logic levels

### **Functional Description**

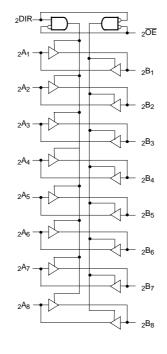
These 16-bit transceivers are designed for use in bidirectional synchronous communication between two buses, where high speed and low power are required. Direction of data flow is controlled by (DIR), the Output Enable ( $\overline{\text{OE}}$ ) transfers data when LOW and isolates the buses when HIGH. The outputs are 24-mA balanced output drivers with current limiting resistors to reduce the need for external terminating resistors and provide for minimal undershoot and reduced ground bounce..

The CY74FCT163H245 has "bus hold" on the data inputs, which retains the input's last state whenever the input goes to high impedance. This eliminates the need for pull-up/down resistors and prevents floating inputs.

The CY74FCT163245 is designed with inputs and outputs capable of being driven by 5.0V buses, allowing its use in mixed voltage systems as a translator. The outputs are also designed with a power off disable feature enabling its use in applications requiring live insertion.

## Logic Block Diagrams CY74FCT163245, CY74FCT163H245

	1B1
	1B2
1A3	1B3
	1B4
1A5	1B5
1A7	1B7
1A8	
	*



	Pin Configuration SSOP/TSSOP Top View						
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	182 GND 183 184 VCC 185 180 GND 183 184 GND 183 184 BND 184 280 284 VCC 285 6 BD 287 286 C 287 286 C 287 286 C 287 286 C 287 286 C 287 286 C 287 287 C 287 C 277 C	1 2 3 4 5 6 7 163245 8 163H245 9 10 11 12 13 14 15 16 17 18 19 20 21 22 23	48         10E           48         10E           46         1A1           46         1A2           45         GND           44         1A3           43         1A4           42         Vcc           41         1A6           39         GND           38         1A7           37         1A8           36         2A1           37         GND           33         2A3           32         2A4           31         Vcc           28         GND           27         2A6           28         GND           27         2A6           28         QND				



## CY74FCT163245 CY74FCT163H245

### **Pin Description**

Name	Description
ŌĒ	Three-State Output Enable Inputs (Active LOW)
DIR	Direction Control
A	Inputs or Three-State Outputs <sup>[1]</sup>
В	Inputs or Three-State Outputs <sup>[1]</sup>

#### **Function Table**<sup>[2]</sup>

Inp	uts	
OE	DIR	Outputs
L	L	Bus B Data to Bus A
L	Н	Bus A Data to Bus B
Н	Х	High Z State

### Maximum Ratings<sup>[3, 4]</sup>

(Above which the useful life may be impaired. For user guide lines, not tested.)	э-
Storage Temperature55°C to +125°C	)
Ambient Temperature with Power Applied–55°C to +125°C	2
Supply Voltage Range0.5V to 4.6	/
DC Input Voltage0.5V to +7.0\	/
DC Output Voltage0.5V to +7.0V	/
DC Output Current (Maximum Sink Current/Pin)60 to +120 mA	٩
Power Dissipation1.0W	I

## **Operating Range**

Range	Ambient Temperature	V <sub>cc</sub>
Industrial	-40°C to +85°C	2.7V to 3.6V

## Electrical Characteristics for Non Bus Hold Devices Over the Operating Range V<sub>CC</sub>=2.7V to 3.6V

Parameter	Description	Test Con	ditions	Min.	<b>Typ.</b> <sup>[5]</sup>	Max.	Unit
V <sub>IH</sub>	Input HIGH Voltage	All Inputs		2.0		5.5	V
V <sub>IL</sub>	Input LOW Voltage					0.8	V
V <sub>H</sub>	Input Hysteresis <sup>[6]</sup>				100		mV
V <sub>IK</sub>	Input Clamp Diode Voltage	V <sub>CC</sub> =Min., I <sub>IN</sub> =-18	3 mA		-0.7	-1.2	V
I <sub>IH</sub>	Input HIGH Current	V <sub>CC</sub> =Max., V <sub>I</sub> =5.5				±1	μΑ
I <sub>IL</sub>	Input LOW Current	V <sub>CC</sub> =Max., V <sub>I</sub> =GND				±1	μΑ
I <sub>OZH</sub>	High Impedance Output Current (Three-State Output pins)	V <sub>CC</sub> =Max., V <sub>OUT</sub> =5.5V				±1	μA
I <sub>OZL</sub>	High Impedance Output Current (Three-State Output pins)	V <sub>CC</sub> =Max., V <sub>OUT</sub> =GND				±1	μΑ
I <sub>OS</sub>	Short Circuit Current <sup>[7]</sup>	V <sub>CC</sub> =Max., V <sub>OUT</sub> =	GND	-60	-135	-240	mA
I <sub>OFF</sub>	Power-Off Disable	V <sub>CC</sub> =0V, V <sub>OUT</sub> ≤4.	5V			±100	μA
I <sub>CC</sub>	Quiescent Power Supply Current	V <sub>IN</sub> ≤0.2V, V <sub>IN</sub> ≥V <sub>CC</sub> −0.2V	V <sub>CC</sub> =Max.		0.1	10	μA
$\Delta I_{CC}$	Quiescent Power Supply Current (TTL inputs HIGH)	V <sub>IN</sub> =V <sub>CC</sub> -0.6V <sup>[8]</sup>	V <sub>CC</sub> =Max.		2.0	30	μA

Note:

1. 2. 3.

On the CY74FCT163H245, these pins have bus hold. H = HIGH Voltage Level. L = LOW Voltage Level. X = Don't Care. Z = High Impedance. Operation beyond the limits set forth may impair the useful life of the device. Unless otherwise noted, these limits are over the operating free-air temperature range.

Typical values are at  $V_{CC}$ =3.3V,  $T_A$  = +25°C ambient. This parameter is specified but not tested. 4.

5

6. 7.

o. This parameter is specified but not tested.
7. Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parametric tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.
8. Per TTL driven input; all other inputs at V<sub>CC</sub> or GND.



Parameter	Description	Test Conditions		Min.	<b>Typ.</b> <sup>[5]</sup>	Max.	Unit
V <sub>IH</sub>	Input HIGH Voltage	All Inputs		2.0		V <sub>CC</sub>	V
V <sub>IL</sub>	Input LOW Voltage					0.8	V
V <sub>H</sub>	Input Hysteresis <sup>[6]</sup>				100		mV
V <sub>IK</sub>	Input Clamp Diode Voltage	V <sub>CC</sub> =Min., I <sub>IN</sub> =-1	8 mA		-0.7	-1.2	V
I <sub>IH</sub>	Input HIGH Current	V <sub>CC</sub> =Max., V <sub>I</sub> =V <sub>C</sub>	c			±100	μΑ
IIL	Input LOW Current					±100	μΑ
I <sub>BBH</sub>	Bus Hold Sustain Current on Bus Hold Input <sup>[9]</sup>	V <sub>CC</sub> =Min.	V <sub>I</sub> =2.0V	-50			μA
IBBL			V <sub>I</sub> =0.8V	+50			μΑ
I <sub>BHHO</sub> I <sub>BHLO</sub>	Bus Hold Overdrive Current on Bus Hold Input <sup>[9]</sup>	V <sub>CC</sub> =Max., V <sub>I</sub> =1.5	5V			±500	μΑ
I <sub>OZH</sub>	High Impedance Output Current (Three-State Output pins)	V <sub>CC</sub> =Max., V <sub>OUT</sub> =	=V <sub>CC</sub>			±1	μΑ
I <sub>OZL</sub>	High Impedance Output Current (Three-State Output pins)	V <sub>CC</sub> =Max., V <sub>OUT</sub>				±1	μA
I <sub>OS</sub>	Short Circuit Current <sup>[7]</sup>	V <sub>CC</sub> =Max., V <sub>OUT</sub> =	=GND	-60	-135	-240	mA
I <sub>OFF</sub>	Power-Off Disable	V <sub>CC</sub> =0V, V <sub>OUT</sub> ≤4.	.5V			±100	μΑ
I <sub>CC</sub>	Quiescent Power Supply Current	V <sub>IN</sub> ≥V <sub>CC</sub> –0.2V	V <sub>CC</sub> =Max.			+40	μA
$\Delta_{ICC}$	Quiescent Power supply Current (TTL inputs HIGH)	V <sub>IN</sub> =V <sub>CC</sub> −0.6V <sup>[8]</sup>	V <sub>CC</sub> =Max.			+350	μA

## Electrical Characteristics For Bus Hold Devices Over the Operating Range $V_{CC}$ =2.7V to 3.6V

## Electrical Characteristics For Balanced Drive Devices Over the Operating Range V<sub>CC</sub>=2.7V to 3.6V

Parameter	Description	Test Conditions	Min.	<b>Typ.</b> <sup>[5]</sup>	Max.	Unit
I <sub>ODL</sub>	Output LOW Dynamic Current <sup>[7]</sup>	V <sub>CC</sub> =3.3V, V <sub>IN</sub> =V <sub>IH</sub> or V <sub>IL</sub> , V <sub>OUT</sub> =1.5V	45		180	mA
I <sub>ODH</sub>	Output HIGH Dynamic Current <sup>[7]</sup>	V <sub>CC</sub> =3.3V, V <sub>IN</sub> =V <sub>IH</sub> or V <sub>IL</sub> , V <sub>OUT</sub> =1.5V	-45		-180	mA
V <sub>OH</sub>	Output HIGH Voltage	V <sub>CC</sub> =Min., I <sub>OH</sub> = -0.1 mA	V <sub>CC</sub> -0.2			V
		V <sub>CC</sub> =Min., I <sub>OH</sub> = -8 mA	2.4 <sup>[10]</sup>	3.0		V
		V <sub>CC</sub> =3.0V, I <sub>OH</sub> = -24 mA	2.0	3.0		V
V <sub>OL</sub>	Output LOW Voltage	V <sub>CC</sub> =Min., I <sub>OL</sub> = 0.1mA			0.2	V
		V <sub>CC</sub> =Min., I <sub>OL</sub> = 24 mA		0.3	0.55	

Notes:

9. Pins with bus hold are described in Pin Description. 10.  $V_{OH}=V_{CC}=0.6V$  at rated current.

## **Capacitance**<sup>[6]</sup>(T<sub>A</sub> = +25°C, f = 1.0 MHz)

Parameter	Description	Test Conditions	<b>Typ.</b> <sup>[5]</sup>	Max.	Unit
C <sub>IN</sub>	Input Capacitance	$V_{IN} = 0V$	4.5	6.0	pF
C <sub>OUT</sub>	Output Capacitance	V <sub>OUT</sub> = 0V	5.5	8.0	pF



## CY74FCT163245 CY74FCT163H245

### **Power Supply Characteristics**

Parameter	Description	Test Condition	ons	<b>Typ.</b> <sup>[5]</sup>	Max.	Unit
ICCD	Dynamic Power Supply Current <sup>[11]</sup>	V <sub>CC</sub> =Max., One Input Toggling, 50% Duty Cycle, Outputs Open, OE=GND	V <sub>IN</sub> =V <sub>CC</sub> or V <sub>IN</sub> =GND	50	75	µA/MHz
I <sub>C</sub>	Total Power Supply Current <sup>[12]</sup>	Duty Cycle, Outputs Open, One	V <sub>IN</sub> =V <sub>CC</sub> or V <sub>IN</sub> =GND	0.5	0.8	mA
		Bit Toggling, OE=GND	V <sub>IN</sub> =V <sub>CC</sub> -0.6V or V <sub>IN</sub> =GND	0.5	0.8	mA
		Duty Cycle, Outputs Open, Six-	V <sub>IN</sub> =V <sub>CC</sub> or V <sub>IN</sub> =GND	2.0	3.0 <sup>[13]</sup>	mA
		teen Bits Toggling, OE=GND	V <sub>IN</sub> =V <sub>CC</sub> -0.6V or V <sub>IN</sub> =GND	2.0	3.3 <sup>[13]</sup>	mA

## Switching Characteristics Over the Operating Range $V_{CC}$ =3.0V to 3.6V<sup>[14,15]</sup>

		CY74FCT CY74FCT		CY74FCT CY74FCT	163245C 163H245C		
Parameter	Description	Min.	Max.	Min.	Max.	Unit	Fig. No. <sup>[16]</sup>
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Data to Output	1.5	4.8	1.5	4.1	ns	1, 3
t <sub>PZH</sub> t <sub>PZL</sub>	Output Enable Time	1.5	6.2	1.5	5.8	ns	1, 7, 8
t <sub>PHZ</sub> t <sub>PLZ</sub>	Output Disable Time	1.5	5.6	1.5	5.2	ns	1, 7, 8
t <sub>SK(O)</sub>	Output Skew <sup>[17]</sup>		0.5		0.5	ns	

Notes:

This parameter is not directly testable, but is derived for use in Total Power Supply calculations.  $\begin{aligned} I_{C} &= I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC} \\ I_{C} &= I_{CC} + \Delta I_{CC} D_{H} N_{T} + I_{CCD} (f_{0}/2 + f_{1} N_{1}) \\ I_{CC} &= Quiescent Current with CMOS input levels \\ \Delta I_{CC} &= Power Supply Current for a TTL HIGH input (V_{IN}=3.4V) \\ D_{H} &= Duty Cycle for TTL inputs HIGH \\ N_{L} &= Number of TTL inputs the CMOS \\ N_{L} &= Number of TTL inputs test D_{L} \end{aligned}$ 11. 12.

- = Number of TTL inputs at D<sub>H</sub> NT
- $I_{CCD}$  = Dynamic Current caused by an input transition pair (HLH or LHL)
- = Clock frequency for registered devices, otherwise zero f<sub>0</sub>

 $f_1$  = Input signal frequency  $f_1$  = Number of inputs changing at  $f_1$ All currents are in milliamps and all frequencies are in megahertz. Values for these conditions are examples of the I<sub>CC</sub> formula. These limits are specified but not tested. 13.

Values for these conducts are specified but not tested on Propagation Delays.
 Minimum limits are specified but not tested on Propagation Delays.
 For V<sub>CC</sub> =2.7, propagation delay, output enable and output disable times should be degraded by 20%.
 See "Parameter Measurement Information" in the General Information section.
 Skew between any two outputs of the same package switching in the same direction. This parameter is ensured by design.

## Ordering Information CY74FCT163245

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
4.1	CY74FCT163245CPACT	Z48	48-Lead (240-Mil) TSSOP	Industrial
	CY74FCT163245CPVC/PVCT	O48	48-Lead (300-Mil) SSOP	
4.8	CY74FCT163245APACT	Z48	48-Lead (240-Mil) TSSOP	Industrial
	CY74FCT163245APVC/PVCT	O48	48-Lead (300-Mil) SSOP	



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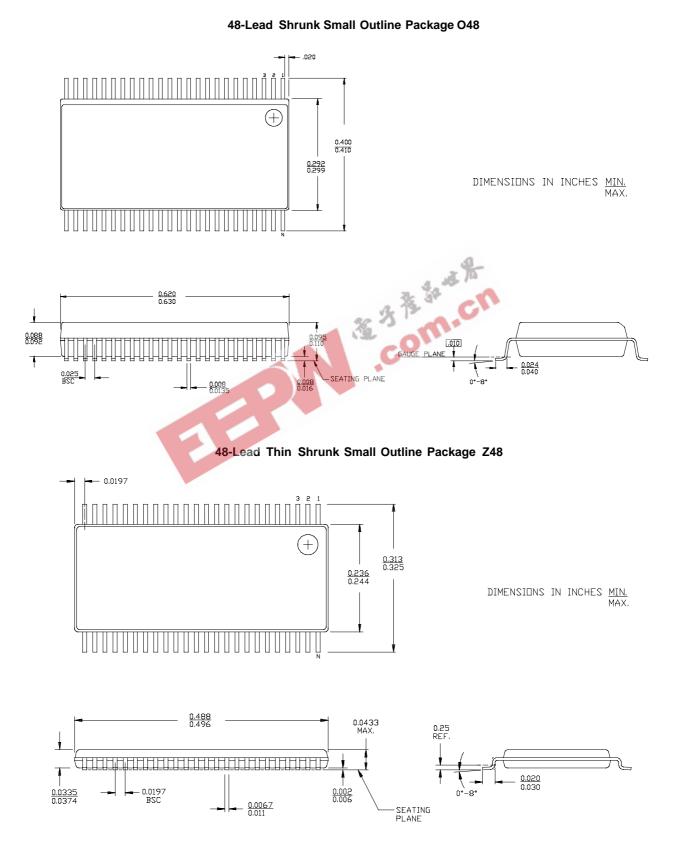
## Ordering Information CY74FCT163H245

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
4.1	74FCT163H245CPACT	Z48	48-Lead (240-Mil) TSSOP	Industrial
	CY74FCT163H245CPVC	O48	48-Lead (300-Mil) SSOP	_
	74FCT163H245CPVCT	O48	48-Lead (300-Mil) SSOP	_
4.8	CY74FCT163H245APVC	O48	48-Lead (300-Mil) SSOP	Industrial
	74FCT163H245APVCT	O48	48-Lead (300-Mil) SSOP	



# TEXAS INSTRUMENTS

## **Package Diagrams**



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